L Number	Hits	Search Text	DB	Time stamp
8	1224	118/600.ccls. or 118/58.ccls. or	USPAT	2004/04/08 14:18
	1221	414/935.ccls.	001	2001,01,00 11.10
9	1201	(118/600.ccls. or 118/58.ccls. or	USPAT	2004/04/08 14:24
	1201	414/935.ccls.) not (2004.ay. or 2003.ay.	"""	2001, 01, 00 21.21
		or 2002.av.)		
10	15	_ · · · · · · · · · · · · · · · · · · ·	USPAT	2004/04/08 14:24
		414/935.ccls.) not (2004.ay. or 2003.ay.		
		or 2002.ay.)) and (adhesion and bake and		
		cool\$3)		
_	20	semiconductor adj fabricat\$4 adj device	USPAT	2004/04/08 14:17
_	0	(semiconductor adj fabricat\$4 adj device)	USPAT	2003/08/21 16:16
		and (air adj flow)		
-	4	(semiconductor adj fabricat\$4 adj device)	USPAT	2003/08/21 16:16
		and ammonia		
-	10	semiconductor adj fabricating adj device	USPAT	2003/08/21 16:18
-	0	wafer and photoresist	USPAT	2003/08/21 16:18
-	1543		USPAT	2003/08/21 16:18
-	3	((wafer and photo-resist) and ammonia) and	USPAT	2003/08/21 16:23
		(air adj flow)		
-	1024	semiconductor and (clean adj air)	USPAT	2003/08/21 16:24
-	131	(semiconductor and (clean adj air)) and	USPAT	2003/08/21 17:24
]		ammonia		
-	317	semiconductor and (HMDS) and adhesion	USPAT	2003/08/21 17:24
-	64	semiconductor and (HMDS) and (adhesion adj	USPAT	2003/08/21 17:26
		unit)		
-	51	(semiconductor and (HMDS) and (adhesion	USPAT	2003/08/21 17:55
	_	adj unit)) AND AIR		/ /
-	0	(("5826129").PN.) and ammonia	USPAT	2003/08/21 18:02
-	1	(("5826129").PN.) and HMDS	USPAT	2004/04/08 14:07
-	243		USPAT	2003/08/21 18:09
-	88	hexamethyldisilizane and adhesion	USPAT	2003/08/21 18:09
_	0	(("3549368").PN.) and hexamethyldisilizane	USPAT	2003/08/21 18:10
-	0	(("3549368").PN.) and HMDS	USPAT	2003/08/21 18:10
-	1	("3549368").PN.	USPAT	2003/08/21 18:10
_	49	HMDS with ammonia	USPAT	2003/08/21 18:35 2004/04/08 14:04
-	1 122		USPAT USPAT	2004/04/08 14:04
-	123	(wafer and photo-resist) and ammonia	USPAT	2004/04/08 14:07
-	486	hasebe.in.	USPAT	2004/04/08 14:09
-	0 0	(kelzo adj hasebe).in. kelzo and (hasebe).in.	USPAT	2004/04/08 14:09
1 -	0	(keizo adj hasebe).in.	USPAT	2004/04/08 14:09
-	12	keizo and (hasebe).in.	USPAT	2004/04/08 14:10
L	12	AEIZO and (Masebe).III.	LOSEVI	2004/04/00 14.10